

N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent RDS(ON) with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

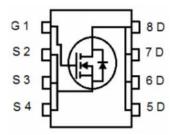
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS min@Tjmax}	710	V
R _{DS(ON)TYP}	60	mΩ
ID	45	Α
Qg	65	nC



Schematic diagram

♦ Intrinsic fast-recovery body diode

Package Marking And Ordering Information

•	•	
Device	Device Package	Marking
NCE65NF068V	DFN8*8	NCE65NF068V

Pint:G S S

DFN 8X8

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	V _{DS}	650	V
Gate-Source Voltage (VDS=0V) AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	45	А
Continuous Drain Current at Tc=100°C	I _{D (DC)}	31.5	А
Pulsed drain current (Note 1)	I _{DM (pluse)}	135	А
Maximum Power Dissipation(Tc=25°C)	P _D	371	W
Derate above 25°C		2.47	w/°C
Single pulse avalanche energy (Note 2)	Eas	400	mJ
Avalanche current ^(Note 1)	I _{AS}	10	А
Repetitive Avalanche energy ,t _{AR} limited by T _{jmax} (Note 1)	Ear	0.9	mJ
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub>	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55+175	°C



^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance,Junction-to-Case(Maximum)	R _{thJC}	0.40	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =1mA 650				V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			10	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			300	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =500μA	3.5	4	5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =23A		64	72	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}			3900	4400	pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		132		pF
Reverse Transfer Capacitance	C _{rss}	F=1.0IVIH2		14		pF
Total Gate Charge	Qg			65	70	nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =23A,		21		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V f = 1 MHz open drain		17		nC
Gate plateau voltage	Vgp			6.5		V
Intrinsic gate resistance	R _G			3		Ω
Switching times						
Turn-on Delay Time	t _{d(on)}			42		nS
Turn-on Rise Time	t _r	V_{DD} =380 V , I_{D} =23 A ,		14		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=1.7\Omega, V_{GS}=10V$		90		nS
Turn-Off Fall Time	t _f			12		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05%0			45	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			135	Α
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =45A,V _{GS} =0V		1.0	1.2	V
Reverse Recovery Time	t _{rr}	Ti-25°C I -22 A		173		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =23A,		1.13		uC
Peak Reverse Recovery Current	I _{rrm}	di/dt=100A/μs		13		Α

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

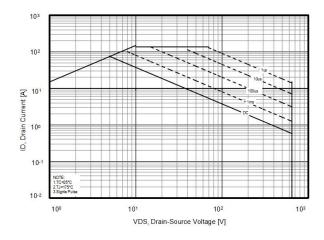


Figure 3. Source-Drain Diode Forward Voltage

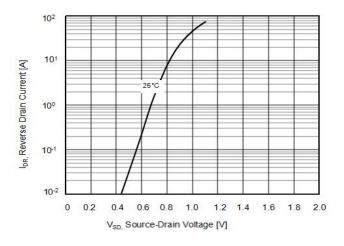


Figure 5. RDS(ON) vs Junction Temperature

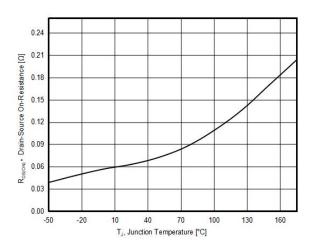


Figure 2. Capacitance

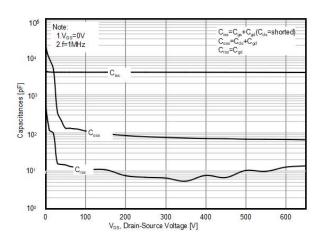


Figure 4. Output characteristics

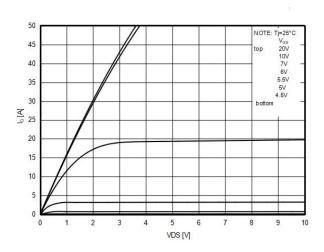


Figure 6. BV_{DSS} vs Junction Temperature

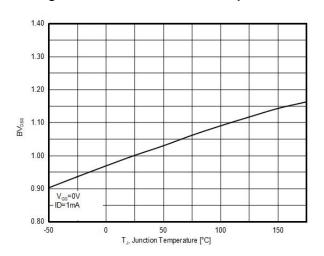




Figure 7. Maximum ID vs Junction Temperature

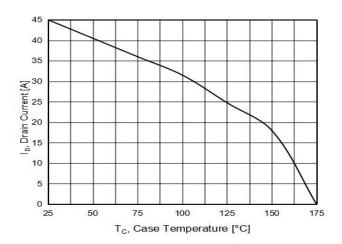


Figure 9. Static drain-source on resistance

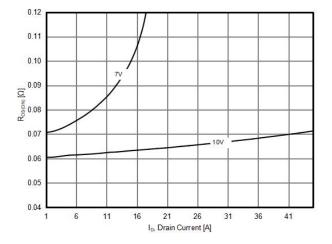


Figure 8. Gate charge waveforms

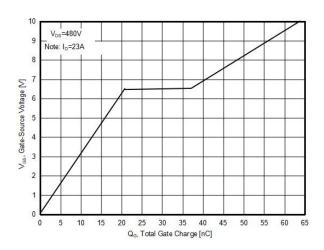
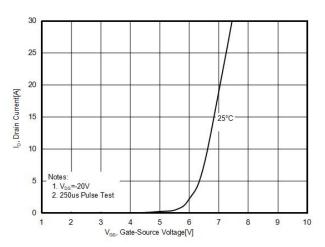


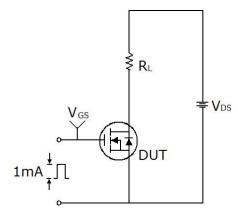
Figure 10. Transfer characteristics

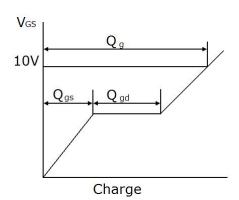




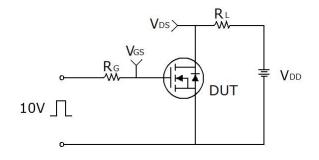
Test circuit

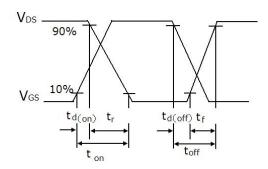
1) Gate charge test circuit & Waveform



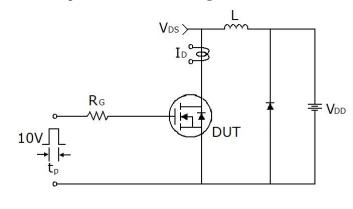


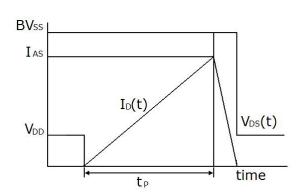
2) Switch Time Test Circuit:





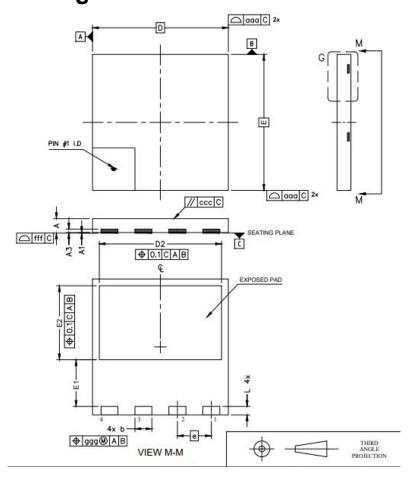
3) Unclamped Inductive Switching Test Circuit & Waveforms







DFN8X8-B Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
Зушьог	Min.	Max.	Min.	Max.
Α	0.75	0.95	0.030	0.037
A1	0.00	0.05	0.000	0.002
b	0.90	1.10	0.035	0.043
A3	0.10	0.30	0.004	0.012
D	7.90	8.10	0.311	0.319
E	7.90	8.10	0.311	0.319
D2	7.10	7.30	0.280	0.287
E1	2.65	2.85	0.104	0.112
E2	4.25	4.45	0.167	0.175
е	2.00 BSC		0.079 E	BSC
L	0.40	0.60	0.016	0.024

Wuxi NCE Power Co., Ltd



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